



HIGH-SPEED 64K x 8 DUAL-PORT STATIC RAM

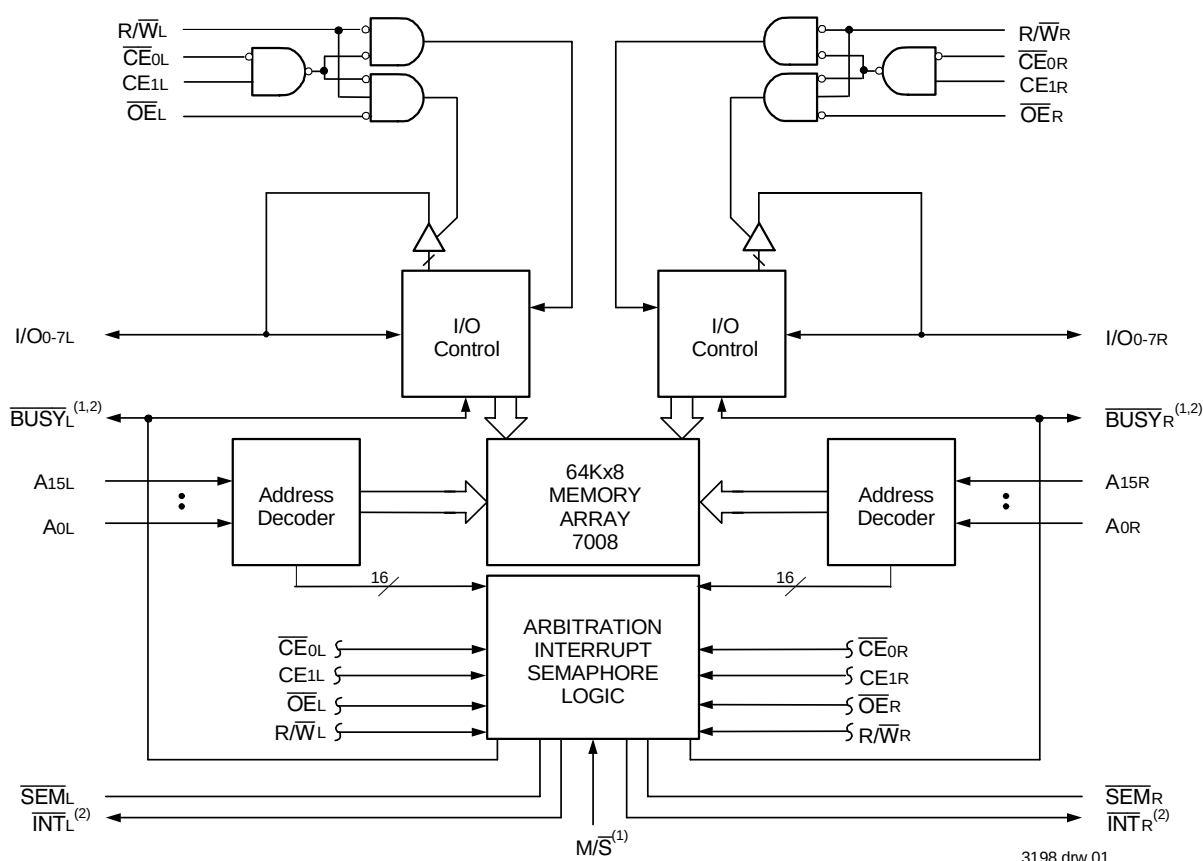
IDT7008S/L

LEAD FINISH (SnPb) ARE IN EOL PROCESS - LAST TIME BUY EXPIRES JUNE 15, 2018

Features

- ♦ True Dual-Ported memory cells which allow simultaneous reads of the same memory location
- ♦ High-speed access
 - Commercial: 15/20/25/35/55ns (max.)
 - Industrial: 20/55ns (max.)
- ♦ Low-power operation
 - IDT7008S
 - Active: 750mW (typ.)
 - Standby: 5mW (typ.)
 - IDT7008L
 - Active: 750mW (typ.)
 - Standby: 1mW (typ.)
- ♦ Dual chip enables allow for depth expansion without external logic
- ♦ IDT7008 easily expands data bus width to 16 bits or more using the Master/Slave select when cascading more than one device
- ♦ $M/\bar{S} = V_{IH}$ for $\overline{BUSY}$ output flag on Master, $M/\bar{S} = V_{IL}$ for $\overline{BUSY}$ input on Slave
- ♦ Interrupt Flag
- ♦ On-chip port arbitration logic
- ♦ Full on-chip hardware support of semaphore signaling between ports
- ♦ Fully asynchronous operation from either port
- ♦ TTL-compatible, single 5V ($\pm 10\%$) power supply
- ♦ Available in 84-pin PGA, 84-pin PLCC, and a 100-pin TQFP
- ♦ Industrial temperature range (-40°C to $+85^{\circ}\text{C}$) is available for selected speeds
- ♦ Green parts available, see ordering information

Functional Block Diagram



NOTES:

1. $\overline{BUSY}$ is an input as a Slave ($M/\bar{S} = V_{IL}$) and an output when it is a Master ($M/\bar{S} = V_{IH}$).
2. $\overline{BUSY}$ and $\overline{INT}$ are non-tri-state totem-pole outputs (push-pull).

3198 drw 01

MARCH 2018

Description

The IDT7008 is a high-speed 64K x 8 Dual-Port Static RAM. The IDT7008 is designed to be used as a stand-alone 512K-bit Dual-Port RAM or as a combination MASTER/SLAVE Dual-Port RAM for 16-bit-or-more word systems. Using the IDT MASTER/SLAVE Dual-Port RAM approach in 16-bit or wider memory system applications results in full-speed, error-free operation without the need for additional discrete logic.

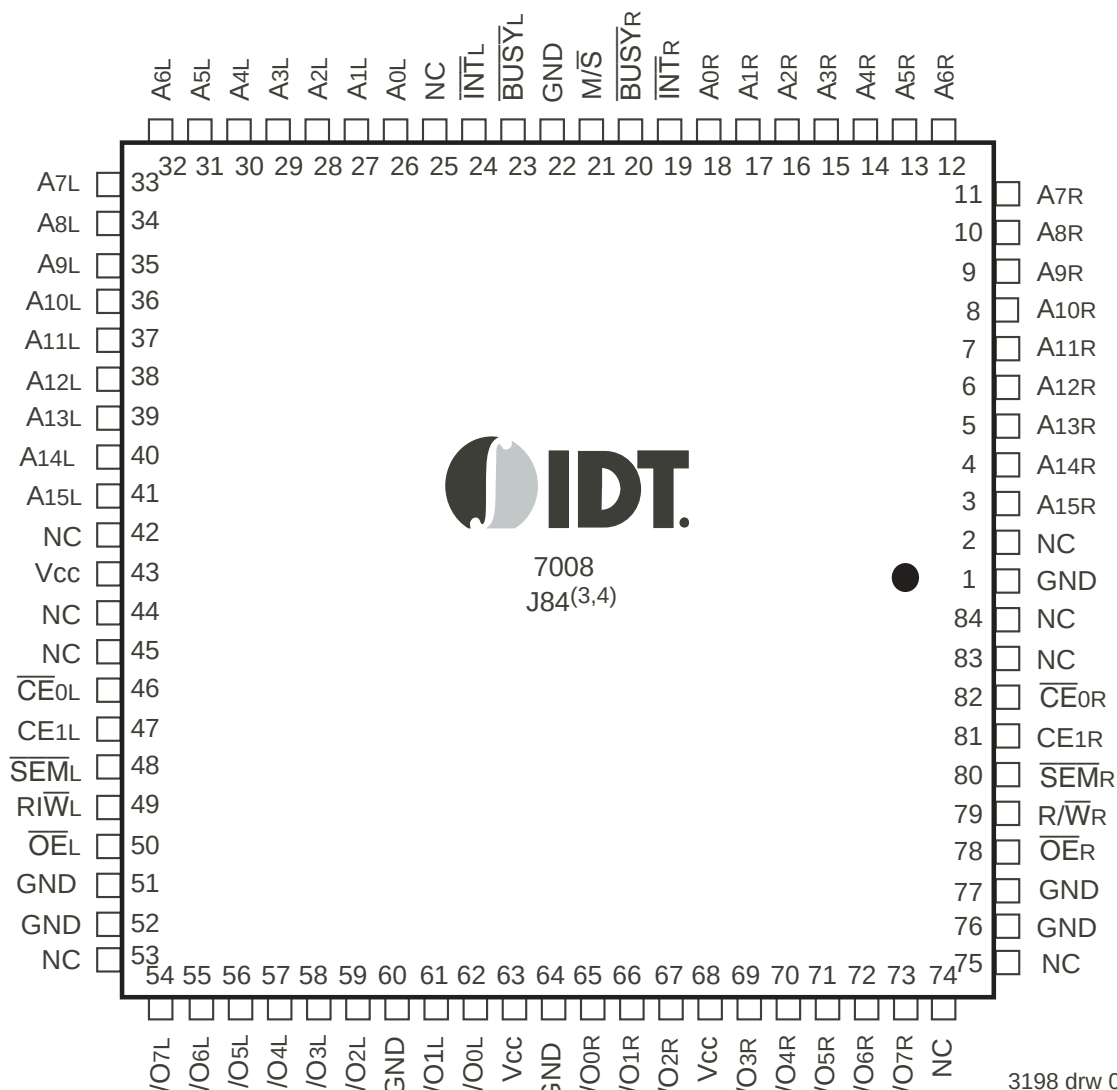
This device provides two independent ports with separate control, address, and I/O pins that permit independent, asynchronous access for

reads or writes to any location in memory. An automatic power down feature controlled by the chip enables ($\overline{CE_0}$ and $\overline{CE_1}$) permit the on-chip circuitry of each port to enter a very low standby power mode.

Fabricated using a CMOS high-performance technology, these devices typically operate on only 750mW of power.

The IDT7008 is packaged in a 84-pin Ceramic Pin Grid Array (PGA), a 84-pin Plastic Leadless Chip Carrier (PLCC) and a 100-pin Thin Quad Flatpack (TQFP).

Pin Configurations^(1,2,3)

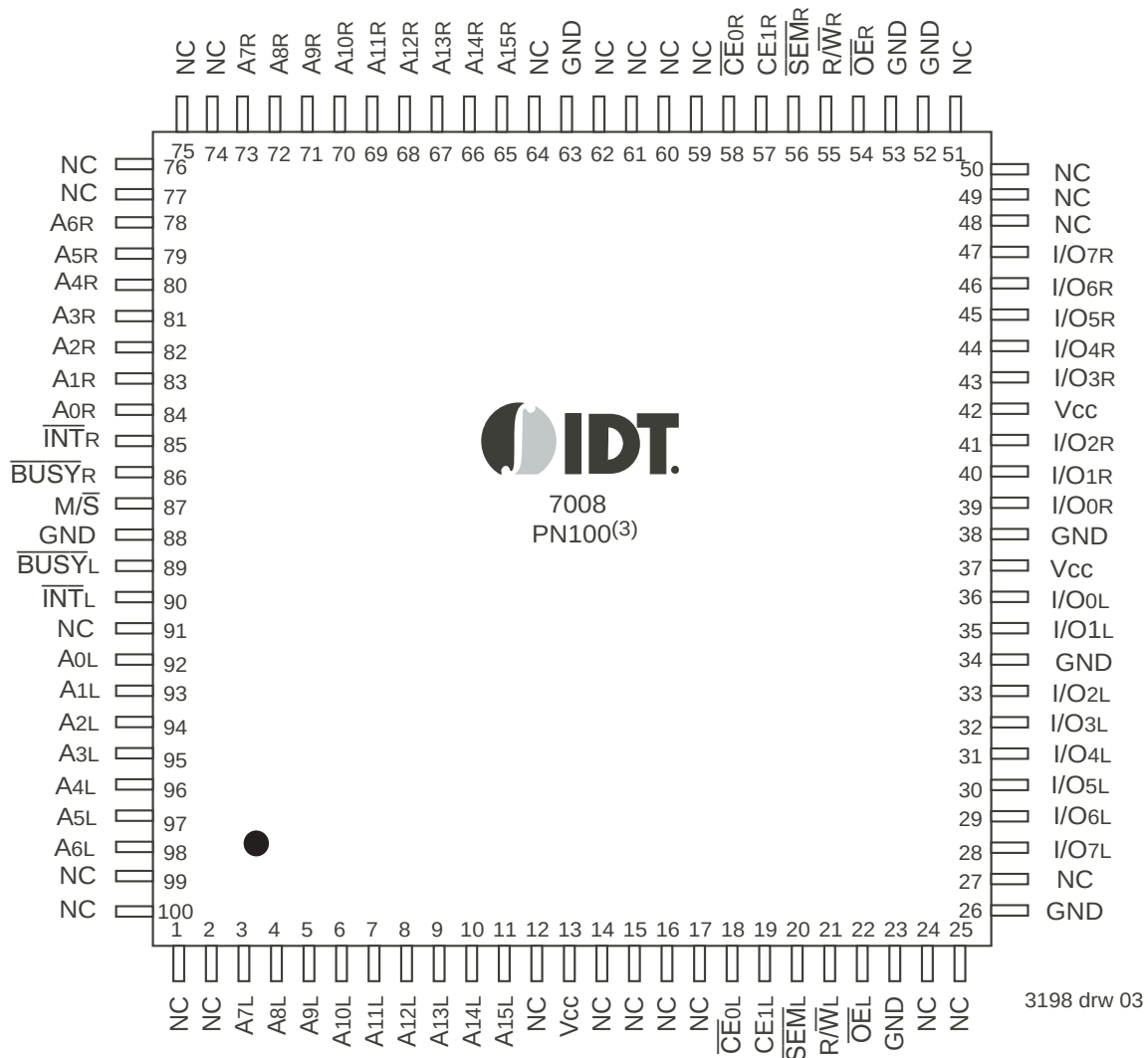


NOTES:

1. All Vcc pins must be connected to power supply.
2. Package body is approximately 1.15 in x 1.15 in x .17 in.
3. This package code is used to reference the package diagram.
4. All GND pins must be connected to ground supply.

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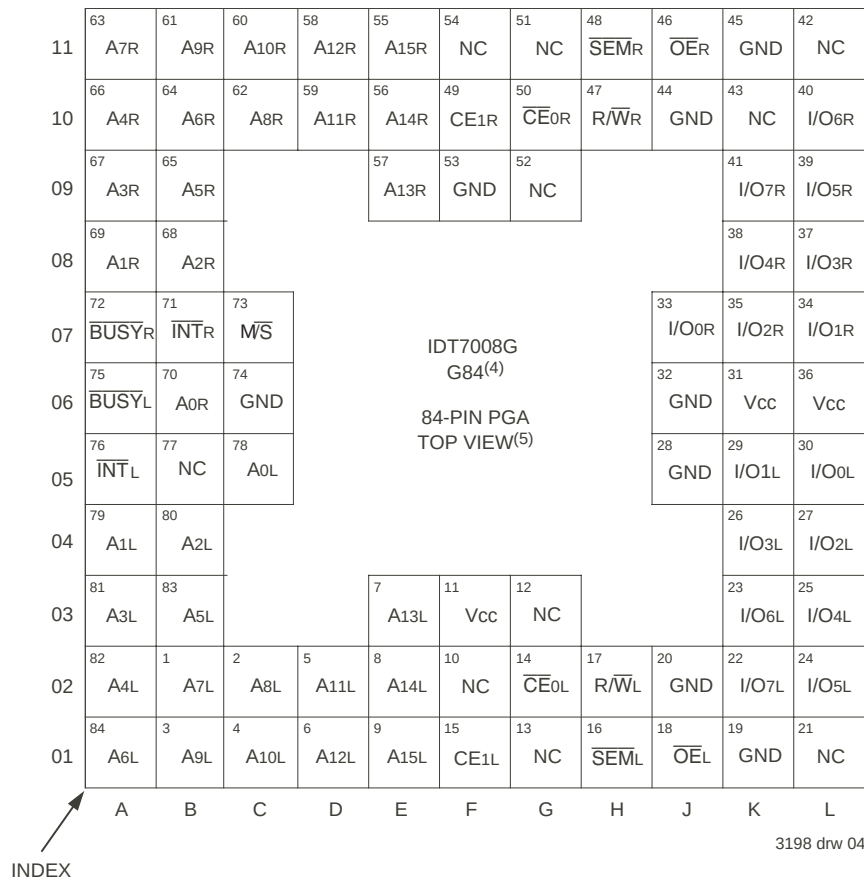
Pin Configurations^(1,2,3) (con't.)



NOTES:

1. All Vcc pins must be connected to power supply.
2. Package body is approximately 14mm x 14mm x 1.4mm.
3. This package code is used to reference the package diagram.

Pin Configurations^(1,2,3) (con't)



NOTES:

1. All Vcc pins must be connected to power supply.
2. All GND pins must be connected to ground supply.
3. Package body is approximately 1.12 in x 1.12 in x .16 in.
4. This package code is used to reference the package diagram.
5. This text does not indicate orientation of the actual part marking.

Pin Names

Left Port	Right Port	Names
$\overline{CE}0L$, CE1L	$\overline{CE}0R$, CE1R	Chip Enables
R/ $\overline{W}L$	R/ $\overline{W}R$	Read/Write Enable
$\overline{OE}L$	$\overline{OE}R$	Output Enable
A0L - A15L	A0R - A15R	Address
I/O0L - I/O7L	I/O0R - I/O7R	Data Input/Output
$\overline{SEM}L$	$\overline{SEM}R$	Semaphore Enable
$\overline{INT}L$	$\overline{INT}R$	Interrupt Flag
$\overline{BUSY}L$	$\overline{BUSY}R$	Busy Flag
M $\overline{S}$		Master or Slave Select
Vcc		Power
GND		Ground

Truth Table I: Chip Enable⁽¹⁾

$\overline{CE}$	$\overline{CE}_0$	CE_1	Mode
L	V_{IL}	V_{IH}	Port Selected (TTL Active)
	$\leq 0.2V$	$\geq V_{CC} - 0.2V$	Port Selected (CMOS Active)
H	V_{IH}	X	Port Deselected (TTL Inactive)
	X	V_{IL}	Port Deselected (TTL Inactive)
	$\geq V_{CC} - 0.2V$	X	Port Deselected (CMOS Inactive)
	X	$\leq 0.2V$	Port Deselected (CMOS Inactive)

3198 tbl 02

NOTES:

1. Chip Enable references are shown above with the actual $\overline{CE}_0$ and CE_1 levels, $\overline{CE}$ is a reference only.

Truth Table II: Non-Contention Read/Write Control

Inputs ⁽¹⁾				Outputs	Mode
$\overline{CE}^{(2)}$	$R/\overline{W}$	$\overline{OE}$	$\overline{SEM}$	I/O ₀₋₇	
H	X	X	H	High-Z	Deselected: Power-Down
L	L	X	H	DATA _{IN}	Write to memory
L	H	L	H	DATA _{OUT}	Read memory
X	X	H	X	High-Z	Outputs Disabled

3198 tbl 03

NOTES:

1. A_{0L} – A_{15L} ≠ A_{0R} – A_{15R}.
2. Refer to Chip Enable Truth Table.

Truth Table III: Semaphore Read/Write Control⁽¹⁾

Inputs				Outputs	Mode
$\overline{CE}^{(2)}$	$R/\overline{W}$	$\overline{OE}$	$\overline{SEM}$	I/O ₀₋₇	
H	H	L	L	DATA _{OUT}	Read Semaphore Flag Data Out
H	↑	X	L	DATA _{IN}	Write I/O ₀ into Semaphore Flag
L	X	X	L	—	Not Allowed

3198 tbl 04

NOTES:

1. There are eight semaphore flags written to via I/O₀ and read from all the I/Os (I/O₀-I/O₇). These eight semaphore flags are addressed by A₀-A₂.
2. Refer to Chip Enable Truth Table.

Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Commercial & Industrial	Unit
V _{TERM} ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +7.0	V
T _{BIAS}	Temperature Under Bias	-55 to +125	°C
T _{STG}	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current	50	mA

3198 tbl 05

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V_{TERM} must not exceed V_{CC} + 10% for more than 25% of the cycle time or 10ns maximum, and is limited to ≤ 20mA for the period of V_{TERM} ≥ V_{CC} + 10%.

Maximum Operating Temperature and Supply Voltage⁽¹⁾

Grade	Ambient Temperature	GND	V _{CC}
Commercial	0°C to +70°C	0V	5.0V ± 10%
Industrial	-40°C to +85°C	0V	5.0V ± 10%

3198 tbl 06

NOTES:

- This is the parameter T_A. This is the "instant on" case temperature.

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
V _{CC}	Supply Voltage	4.5	5.0	5.5	V
GND	Ground	0	0	0	V
V _{IH}	Input High Voltage	2.2	—	6.0 ⁽²⁾	V
V _{IL}	Input Low Voltage	-0.5 ⁽¹⁾	—	0.8	V

3198 tbl 07

NOTES:

- V_{IL} ≥ -1.5V for pulse width less than 10ns.
- V_{TERM} must not exceed V_{CC} + 10%.

Capacitance

(T_A = +25°C, f = 1.0mhz) (TQFP Only)

Symbol	Parameter	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	9	pF
C _{OUT} ⁽²⁾	Output Capacitance	V _{OUT} = 0V	10	pF

3198 tbl 08

NOTES:

- This parameter is determined by device characterization but is not production tested.
- C_{OUT} also references C_{I/O}.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽²⁾ (V_{CC} = 5.0V ± 10%)

Symbol	Parameter	Test Conditions	7008S		7008L		Unit
			Min.	Max.	Min.	Max.	
I _{LI}	Input Leakage Current ⁽¹⁾	V _{CC} = 5.5V, V _{IN} = 0V to V _{CC}	—	10	—	5	μA
I _{LO}	Output Leakage Current	$\overline{CE} = V_{IH}$, V _{OUT} = 0V to V _{CC}	—	10	—	5	μA
V _{OL}	Output Low Voltage	I _{OL} = 4mA	—	0.4	—	0.4	V
V _{OH}	Output High Voltage	I _{OH} = -4mA	2.4	—	2.4	—	V

3198 tbl 09

NOTES:

- At V_{CC} ≤ 2.0V, input leakages are undefined.
- Refer to Chip Enable Truth Table.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(1,6) ($V_{CC} = 5.0V \pm 10\%$)

Symbol	Parameter	Test Condition	Version	7008X15 Com'l Only		7008X20 Com'l & Ind		7008X25 Com'l Only		Unit	
				Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.		
ICC	Dynamic Operating Current (Both Ports Active)	$\overline{CE} = V_{IL}$, Outputs Disabled $SEM = V_{IH}$ $f = f_{MAX}^{(3)}$	COM'L	S	205	365	190	325	180	305	mA
				L	200	325	180	285	170	265	
			IND	S	—	—	—	—	—	—	
				L	—	—	180	335	—	—	
ISB1	Standby Current (Both Ports - TTL Level Inputs)	$\overline{CEL} = \overline{CER} = V_{IH}$ $SEMR = SEM_L = V_{IH}$ $f = f_{MAX}^{(3)}$	COM'L	S	65	110	50	90	40	85	mA
				L	65	90	50	70	40	60	
			IND	S	—	—	—	—	—	—	
				L	—	—	50	85	—	—	
ISB2	Standby Current (One Port - TTL Level Inputs)	$\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(5)}$ Active Port Outputs Disabled, $f=f_{MAX}^{(3)}$ $SEMR = SEM_L = V_{IH}$	COM'L	S	130	245	115	215	105	200	mA
				L	130	215	115	185	105	170	
			IND	S	—	—	—	—	—	—	
				L	—	—	115	220	—	—	
ISB3	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports $\overline{CEL}$ and $\overline{CER} \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} < 0.2V$, $f = 0^{(4)}$ $SEMR = SEM_L \geq V_{CC} - 0.2V$	COM'L	S	1.0	15	1.0	15	1.0	15	mA
				L	0.2	5	0.2	5	0.2	5	
			IND	S	—	—	—	—	—	—	
				L	—	—	0.2	10	—	—	
ISB4	Full Standby Current (One Port - All CMOS Level Inputs)	$\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{CC} - 0.2V^{(5)}$ $SEMR = SEM_L \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} < 0.2V$ Active Port Outputs Disabled $f = f_{MAX}^{(3)}$	COM'L	S	120	220	110	190	100	170	mA
				L	120	190	110	160	100	145	
			IND	S	—	—	—	—	—	—	
				L	—	—	110	195	—	—	

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Symbol	Parameter	Test Condition	Version	7008X35 Com'l Only		7008X55 Com'l & Ind		Unit	
				Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.		
ICC	Dynamic Operating Current (Both Ports Active)	$\overline{CE} = V_{IL}$, Outputs Disabled $SEM = V_{IH}$ $f = f_{MAX}^{(3)}$	COM'L	S L	160 160	295 255	150 150	270 230	mA
			IND	S L	— —	— —	150 150	310 270	
ISB1	Standby Current (Both Ports - TTL Level Inputs)	$\overline{CE}L = \overline{CE}R = V_{IH}$ $SEMr = SEML = V_{IH}$	COM'L	S L	30 30	85 60	20 20	85 60	mA
			IND	S L	— —	— —	13 13	100 80	
ISB2	Standby Current (One Port - TTL Level Inputs)	$\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(5)}$ Active Port Outputs Disabled, $f=f_{MAX}^{(3)}$ $SEMr = SEML = V_{IH}$	COM'L	S L	95 95	185 155	85 85	165 135	mA
			IND	S L	— —	— —	85 85	195 165	
ISB3	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports $\overline{CE}L$ and $\overline{CE}R \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(4)}$ $SEMr = SEML \geq V_{CC} - 0.2V$	COM'L	S L	1.0 0.2	15 5	1.0 0.2	15 5	mA
			IND	S L	— —	— —	1.0 0.2	30 10	
ISB4	Full Standby Current (One Port - All CMOS Level Inputs)	$\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{CC} - 0.2V^{(5)}$ $SEMr = SEML \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$ Active Port Outputs Disabled $f = f_{MAX}^{(3)}$	COM'L	S L	90 90	160 135	80 80	135 110	mA
			IND	S L	— —	— —	80 80	175 150	

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NOTES:

- 'X' in part numbers indicates power rating (S or L)
- $V_{CC} = 5V$, $T_A = +25^\circ C$, and are not production tested. $I_{CCDC} = 120mA$ (Typ.)
- At $f = f_{MAX}$, address and control lines (except Output Enable) are cycling at the maximum frequency read cycle of 1/ trc, and using "AC Test Conditions" of input levels of GND to 3V.
- $f = 0$ means no address or control lines change.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- Refer to Chip Enable Truth Table.

AC Test Conditions

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	5ns Max.
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	Figures 1 and 2

3198 tbl 11

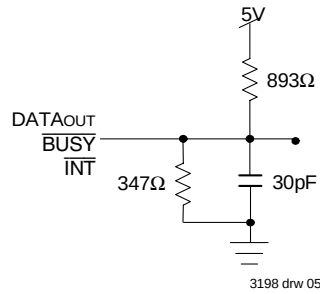


Figure 1. AC Output Test Load

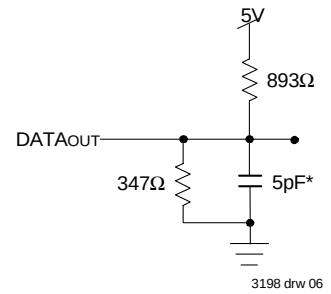
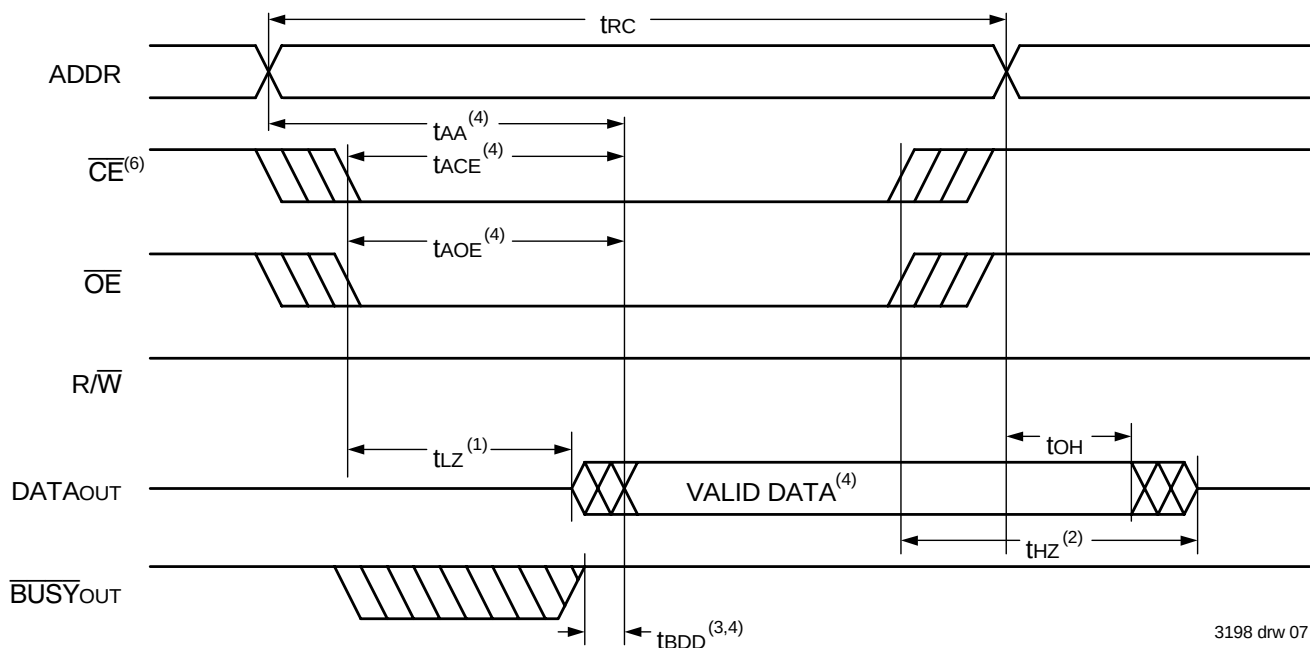


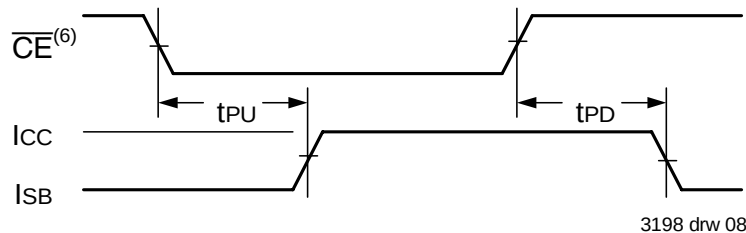
Figure 2. Output Test Load
(for tLZ, tHZ, twz, tow)

* Including scope and jig.

Waveform of Read Cycles⁽⁵⁾



Timing of Power-Up Power-Down



NOTES:

- Timing depends on which signal is asserted last, $\overline{OE}$ or $\overline{CE}$.
- Timing depends on which signal is de-asserted first $\overline{CE}$ or $\overline{OE}$.
- t_{BDD} delay is required only in cases where the opposite port is completing a write operation to the same address location. For simultaneous read operations $\overline{BUSY}$ has no relation to valid output data.
- Start of valid data depends on which timing becomes effective last t_{AOE} , t_{ACE} , t_{AA} or t_{BDD} .
- $\overline{SEM} = V_{IH}$.
- Refer to Chip Enable Truth Table.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽⁶⁾

Symbol	Parameter	7008X15 Com'l Only		7008X20 Com'l & Ind		7008X25 Com'l Only		7008X35 Com'l Only		7008X55 Com'l & Ind		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE												
t _{RC}	Read Cycle Time	15	—	20	—	25	—	35	—	55	—	ns
t _{AA}	Address Access Time	—	15	—	20	—	25	—	35	—	55	ns
t _{ACE}	Chip Enable Access Time ⁽⁴⁾	—	15	—	20	—	25	—	35	—	55	ns
t _{AOE}	Output Enable Access Time	—	10	—	12	—	13	—	20	—	30	ns
t _{OH}	Output Hold from Address Change	3	—	3	—	3	—	3	—	3	—	ns
t _{LZ}	Output Low-Z Time ^(1,2)	3	—	3	—	3	—	3	—	3	—	ns
t _{HZ}	Output High-Z Time ^(1,2)	—	10	—	12	—	15	—	15	—	25	ns
t _{PU}	Chip Enable to Power Up Time ⁽²⁾	0	—	0	—	0	—	0	—	0	—	ns
t _{PD}	Chip Disable to Power Down Time ⁽²⁾	—	15	—	20	—	25	—	35	—	50	ns
t _{SOP}	Semaphore Flag Update Pulse ($\overline{OE}$ or $\overline{SEM}$)	10	—	10	—	12	—	15	—	15	—	ns
t _{SAA}	Semaphore Address Access Time	—	15	—	20	—	25	—	35	—	55	ns

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AC Electrical Characteristics Over the Operating Temperature and Supply Voltage⁽⁶⁾

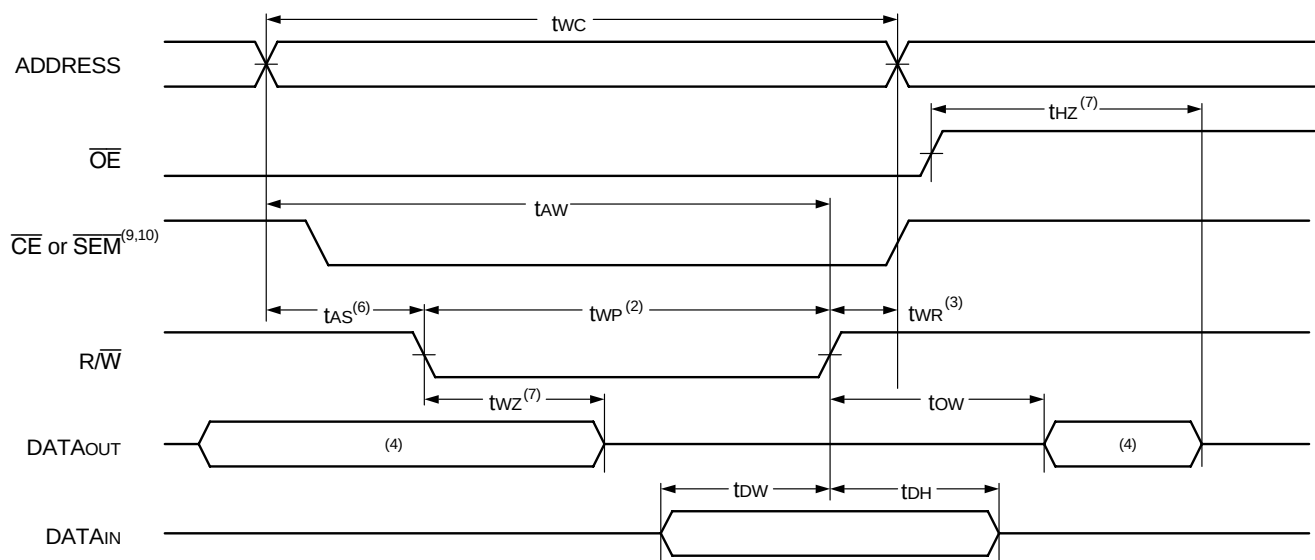
Symbol	Parameter	7008X15 Com'l Only		7008X20 Com'l & Ind		7008X25 Com'l Only		7008X35 Com'l Only		7008X55 Com'l & Ind		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
WRITE CYCLE												
t _{WC}	Write Cycle Time	15	—	20	—	25	—	35	—	55	—	ns
t _{EW}	Chip Enable to End-of-Write ⁽³⁾	12	—	15	—	20	—	30	—	45	—	ns
t _{AW}	Address Valid to End-of-Write	12	—	15	—	20	—	30	—	45	—	ns
t _{AS}	Address Set-up Time ⁽³⁾	0	—	0	—	0	—	0	—	0	—	ns
t _{WP}	Write Pulse Width	12	—	15	—	20	—	25	—	40	—	ns
t _{WR}	Write Recovery Time	0	—	0	—	0	—	0	—	0	—	ns
t _{DW}	Data Valid to End-of-Write	10	—	15	—	15	—	15	—	30	—	ns
t _{HZ}	Output High-Z Time ^(1,2)	—	10	—	12	—	15	—	15	—	25	ns
t _{DH}	Data Hold Time ⁽⁵⁾	0	—	0	—	0	—	0	—	0	—	ns
t _{WZ}	Write Enable to Output in High-Z ^(1,2)	—	10	—	12	—	15	—	15	—	25	ns
t _{OW}	Output Active from End-of-Write ^(1,2,5)	0	—	0	—	0	—	0	—	0	—	ns
t _{SWRD}	SEM Flag Write to Read Time	5	—	5	—	5	—	5	—	5	—	ns
t _{SPS}	SEM Flag Contention Window	5	—	5	—	5	—	5	—	5	—	ns

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NOTES:

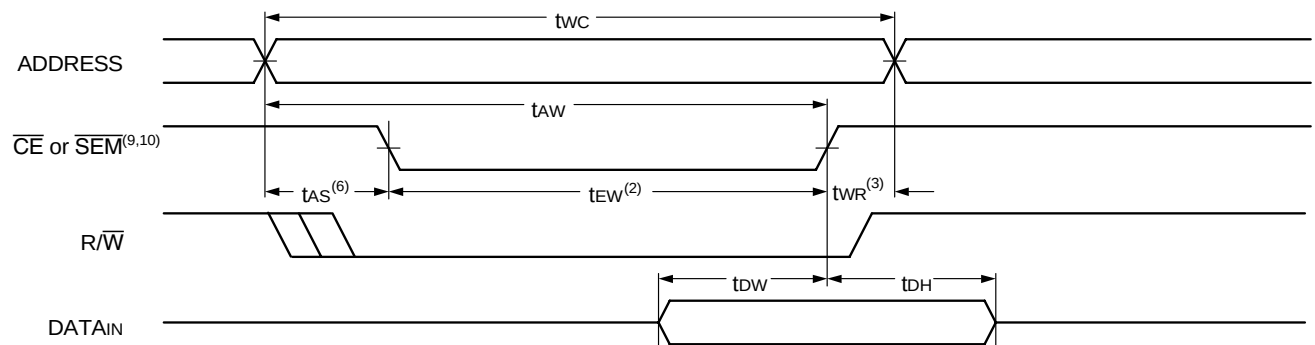
1. Transition is measured 0mV from Low- or High-impedance voltage with Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. To access RAM, $\overline{CE} = V_{IL}$ and $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$ and $\overline{SEM} = V_{IL}$. Either condition must be valid for the entire t_{EW} time.
4. To access RAM, $\overline{CE} = V_{IL}$ and $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$ and $\overline{SEM} = V_{IL}$.
5. The specification for t_{DH} must be met by the device supplying write data to the RAM under all operating conditions. Although t_{DH} and t_{OW} values will vary over voltage and temperature, the actual t_{DH} will always be smaller than the actual t_{OW}.
6. 'X' in part numbers indicates power rating (s or L).

Timing Waveform of Write Cycle No. 1, $R/\overline{W}$ Controlled Timing^(1,5,8)



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Timing Waveform of Write Cycle No. 2, $\overline{CE}$ Controlled Timing^(1,5)

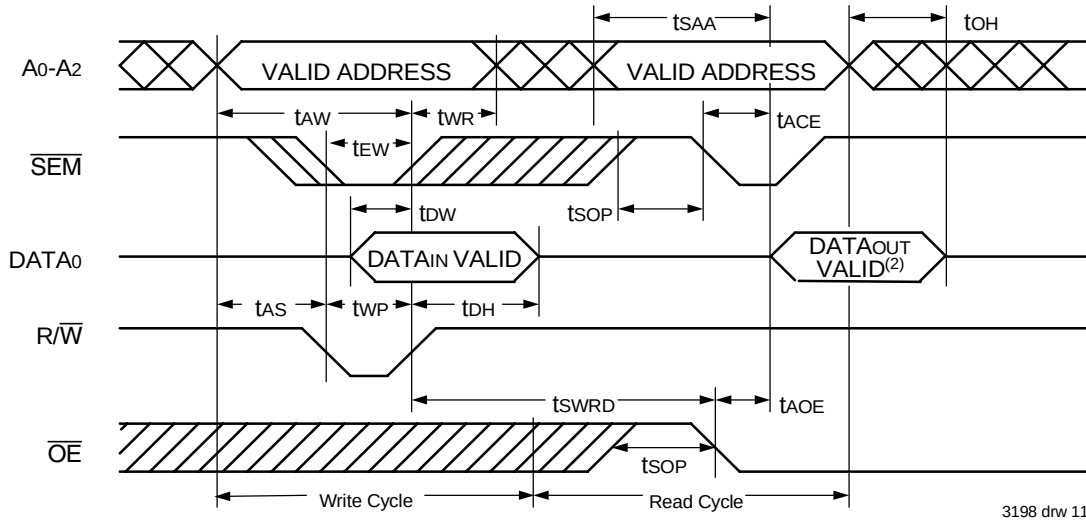


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NOTES:

1. $R/\overline{W}$ or $\overline{CE}$ must be HIGH during all address transitions.
2. A write occurs during the overlap (t_{EW} or t_{WP}) of a LOW $\overline{CE}$ and a LOW $R/\overline{W}$ for memory array writing cycle.
3. t_{WR} is measured from the earlier of $\overline{CE}$ or $R/\overline{W}$ (or $\overline{SEM}$ or $R/\overline{W}$) going HIGH to the end of write cycle.
4. During this period, the I/O pins are in the output state and input signals must not be applied.
5. If the $\overline{CE}$ or $\overline{SEM}$ LOW transition occurs simultaneously with or after the $R/\overline{W}$ LOW transition, the outputs remain in the High-impedance state.
6. Timing depends on which enable signal is asserted last, $\overline{CE}$ or $R/\overline{W}$.
7. This parameter is guaranteed by device characterization, but is not production tested. Transition is measured 0mV from steady state with the Output Test Load (Figure 2).
8. If $\overline{OE}$ is LOW during $R/\overline{W}$ controlled write cycle, the write pulse width must be the larger of t_{WP} or ($t_{WZ} + t_{OW}$) to allow the I/O drivers to turn off and data to be placed on the bus for the required t_{DW} . If $\overline{OE}$ is HIGH during an $R/\overline{W}$ controlled write cycle, this requirement does not apply and the write pulse can be as short as the specified t_{WP} .
9. To access RAM, $\overline{CE} = V_{IL}$ and $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$ and $\overline{SEM} = V_{IL}$. t_{EW} must be met for either condition.
10. Refer to Chip Enable Truth Table.

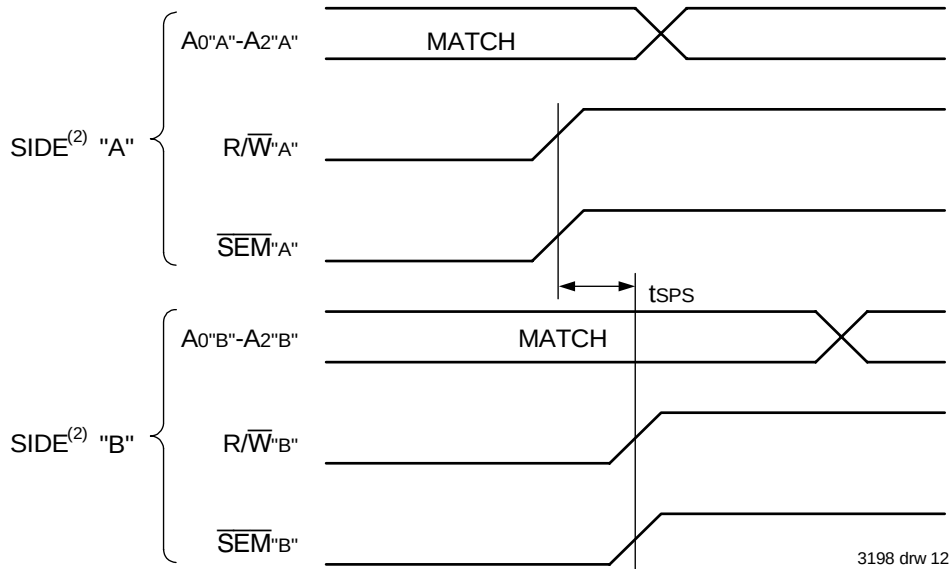
Timing Waveform of Semaphore Read after Write Timing, Either Side⁽¹⁾



NOTES:

1. $\overline{CE} = V_{IH}$ for the duration of the above timing (both write and read cycle) (Refer to Chip Enable Truth Table).
2. "DATAOUT VALID" represents all I/O's (I/O₀ - I/O₁₅) equal to the semaphore value.

Timing Waveform of Semaphore Write Contention^(1,3,4)



NOTES:

1. $DOR = DOL = V_{IL}$, $\overline{CE}_L = \overline{CE}_R = V_{IH}$ (Refer to Chip Enable Truth Table).
2. All timing is the same for left and right ports. Port "A" may be either left or right port. "B" is the opposite from port "A".
3. This parameter is measured from $R/\overline{W}_A$ or $\overline{SEM}_A$ going HIGH to $R/\overline{W}_B$ or $\overline{SEM}_B$ going HIGH.
4. If t_{SPS} is not satisfied, the semaphore will fall positively to one side or the other, but there is no guarantee which side will obtain the flag.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽⁶⁾

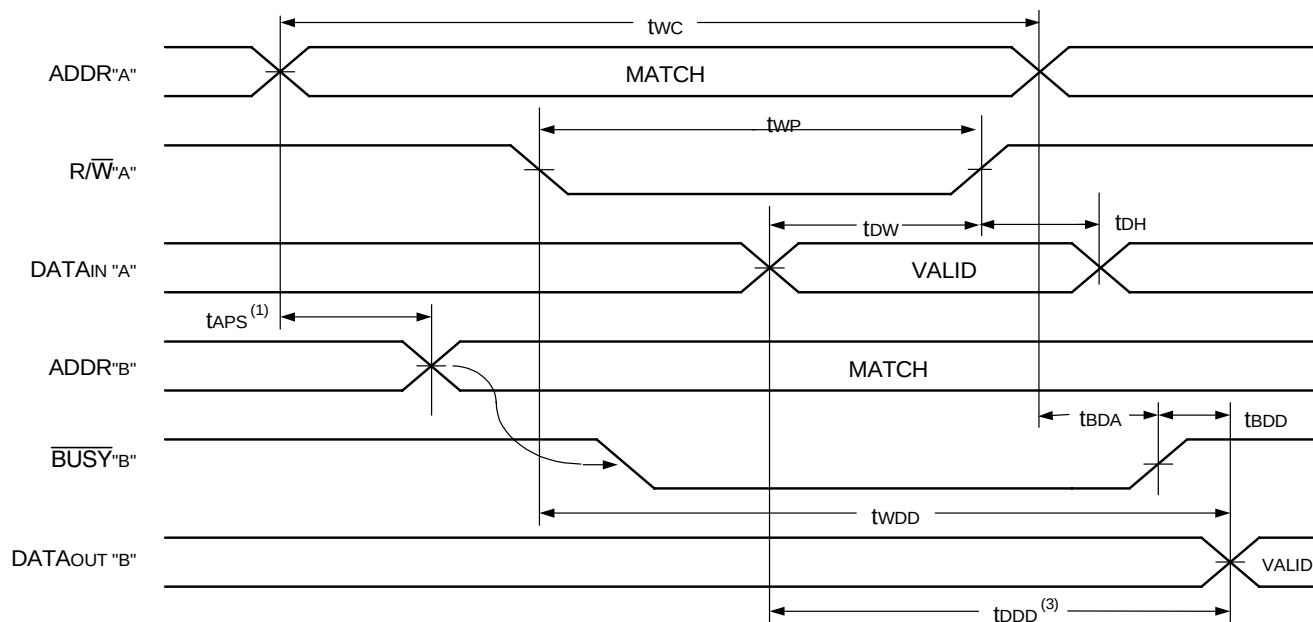
Symbol	Parameter	7008X15 Com'l Only		7008X20 Com'l & Ind		7008X25 Com'l Only		7008X35 Com'l Only		7008X55 Com'l & Ind		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
BUSY TIMING (M/ $\overline{S}$ =V _{IH})												
tBAA	$\overline{BUSY}$ Access Time from Address Match	—	15	—	20	—	20	—	20	—	45	ns
tBDA	$\overline{BUSY}$ Disable Time from Address Not Matched	—	15	—	20	—	20	—	20	—	40	ns
tBAC	$\overline{BUSY}$ Access Time from Chip Enable Low	—	15	—	20	—	20	—	20	—	40	ns
tBDC	$\overline{BUSY}$ Access Time from Chip Enable High	—	15	—	17	—	17	—	20	—	35	ns
tAPS	Arbitration Priority Set-up Time ⁽²⁾	5	—	5	—	5	—	5	—	5	—	ns
tBDD	$\overline{BUSY}$ Disable to Valid Data ⁽³⁾	—	15	—	20	—	25	—	35	—	55	ns
tWH	Write Hold After $\overline{BUSY}$ ⁽⁵⁾	12	—	15	—	17	—	25	—	25	—	ns
BUSY TIMING (M/ $\overline{S}$ =V _{IL})												
tWB	$\overline{BUSY}$ Input to Write ⁽⁴⁾	0	—	0	—	0	—	0	—	0	—	ns
tWH	Write Hold After $\overline{BUSY}$ ⁽⁵⁾	12	—	15	—	17	—	25	—	25	—	ns
PORT-TO-PORT DELAY TIMING												
tWDD	Write Pulse to Data Delay ⁽¹⁾	—	30	—	45	—	50	—	60	—	80	ns
tDDD	Write Data Valid to Read Data Delay ⁽¹⁾	—	25	—	30	—	35	—	45	—	65	ns

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NOTES:

- Port-to-port delay through RAM cells from writing port to reading port, refer to "Timing Waveform of Write with Port-to-Port Read and $\bar{B}USY$ (M/ $\bar{S}$ = V_{IH})".
- To ensure that the earlier of the two ports wins.
- tBDD is a calculated parameter and is the greater of 0, twDD – twP (actual) or tdDD – tdW (actual).
- To ensure that the write cycle is inhibited on port "B" during contention on port "A".
- To ensure that a write cycle is completed on port "B" after contention on port "A".
- 'X' in part numbers indicates power rating (S or L).

Timing Waveform of Write with Port-to-Port Read and $\overline{BUSY}^{(2,5)}$ ($M/\overline{S} = V_{IH}$)⁽⁴⁾

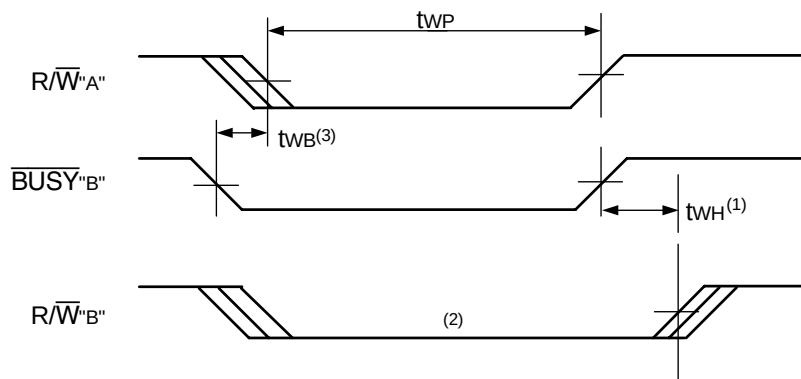


NOTES:

1. To ensure that the earlier of the two ports wins. t_{APS} is ignored for $M/\overline{S} = V_{IL}$ (SLAVE).
2. $\overline{CE}_L = \overline{CE}_R = V_{IL}$, refer to Chip Enable Truth Table.
3. $\overline{OE} = V_{IL}$ for the reading port.
4. If $M/\overline{S} = V_{IL}$ (SLAVE), then $\overline{BUSY}$ is an input ($\overline{BUSY}^A = V_{IH}$ and $\overline{BUSY}^B = \text{"don't care"}$, for this example).
5. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".

3198 drw 13

Timing Waveform of Write with $\overline{BUSY}$ ($M/\overline{S} = V_{IL}$)

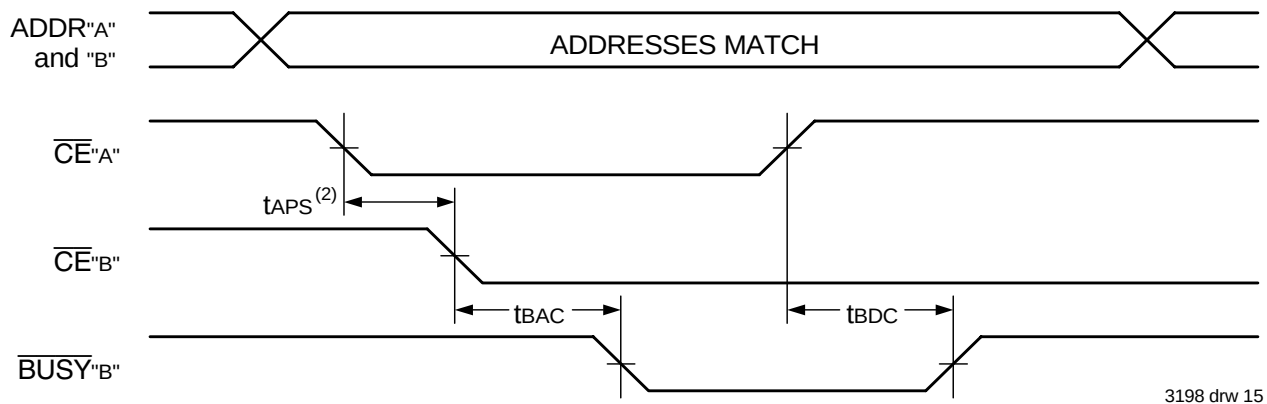


3198 drw 14

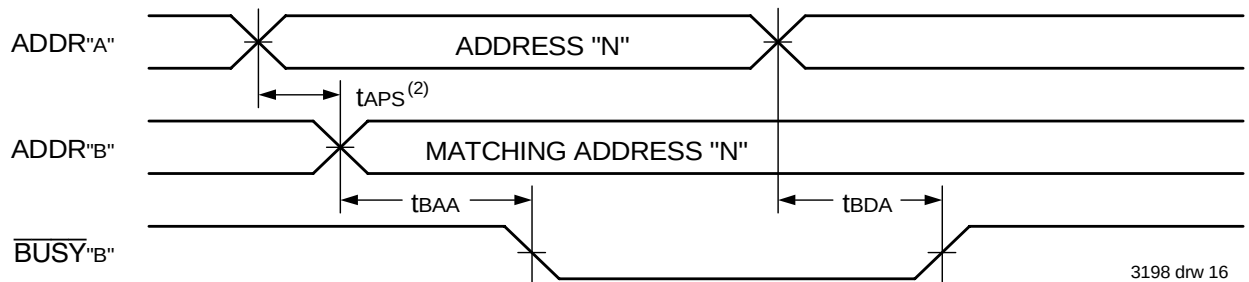
NOTES:

1. t_{WH} must be met for both $\overline{BUSY}$ input (SLAVE) and output (MASTER).
2. $\overline{BUSY}$ is asserted on port "B" blocking R/W^B , until $\overline{BUSY}^B$ goes HIGH.
3. t_{wB} is only for the 'Slave' version.

Waveform of **BUSY** Arbitration Controlled by **CE** Timing^(1,3) ($M/\bar{S} = V_{IH}$)



Waveform of **BUSY** Arbitration Cycle Controlled by Address Match Timing⁽¹⁾ ($M/\bar{S} = V_{IH}$)



NOTES:

1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".
2. If tAPS is not satisfied, the BUSY signal will be asserted on one side or another but there is no guarantee on which side BUSY will be asserted.
3. Refer to Chip Enable Truth Table.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range⁽¹⁾

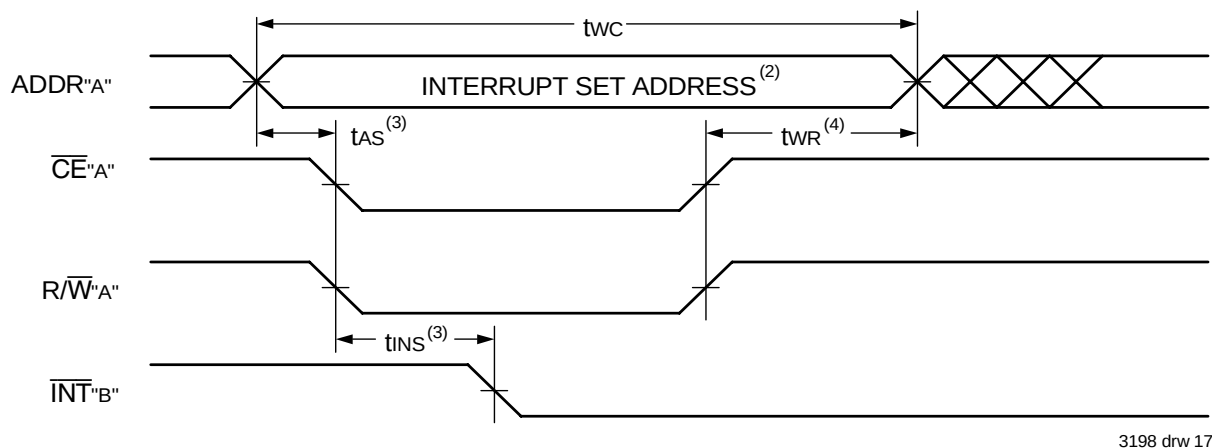
Symbol	Parameter	7008X15 Com'l Only		7008X20 Com'l & Ind		7008X25 Com'l Only		7008X35 Com'l Only		7008X55 Com'l & Ind		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
INTERRUPT TIMING												
tAS	Address Set-up Time	0	—	0	—	0	—	0	—	0	—	ns
tWR	Write Recovery Time	0	—	0	—	0	—	0	—	0	—	ns
tINS	Interrupt Set Time	—	15	—	20	—	20	—	25	—	40	ns
tINR	Interrupt Reset Time	—	15	—	20	—	20	—	25	—	40	ns

3198 tbl 15

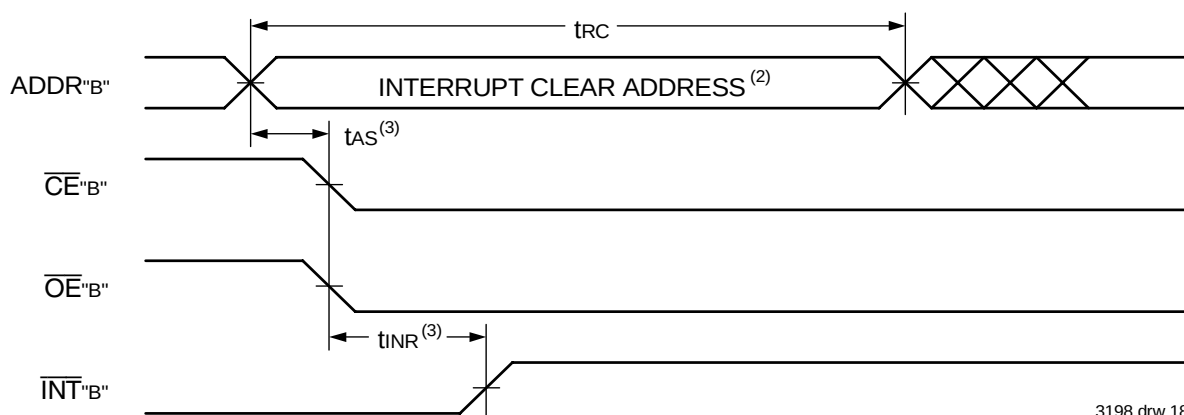
NOTES:

1. 'X' in part numbers indicates power rating (S or L).

Waveform of Interrupt Timing^(1,5)



3198 drw 17



3198 drw 18

NOTES:

1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".
2. See Interrupt Truth Table.
3. Timing depends on which enable signal ($\overline{CE}$ or $R/\overline{W}$) is asserted last.
4. Timing depends on which enable signal ($\overline{CE}$ or $R/\overline{W}$) is deasserted first.
5. Refer to Chip Enable Truth Table.

Truth Table IV — Interrupt Flag^(1,4,5)

Left Port					Right Port					Function
$R/\overline{W}_L$	$\overline{CE}_L$	$\overline{OE}_L$	$A_{15L}-A_{0L}$	$\overline{INT}_L$	$R/\overline{W}_R$	$\overline{CE}_R$	$\overline{OE}_R$	$A_{15R}-A_{0R}$	$\overline{INT}_R$	
L	L	X	FFFF	X	X	X	X	X	$L^{(2)}$	Set Right $\overline{INT}_R$ Flag
X	X	X	X	X	X	L	L	FFFF	$H^{(3)}$	Reset Right $\overline{INT}_R$ Flag
X	X	X	X	$L^{(3)}$	L	L	X	FFFE	X	Set Left $\overline{INT}_L$ Flag
X	L	L	FFFE	$H^{(2)}$	X	X	X	X	X	Reset Left $\overline{INT}_L$ Flag

NOTES:

1. Assumes $\overline{BUSY}_L = \overline{BUSY}_R = V_{IH}$.
2. If $\overline{BUSY}_L = V_{IL}$, then no change.
3. If $\overline{BUSY}_R = V_{IL}$, then no change.
4. $\overline{INT}_L$ and $\overline{INT}_R$ must be initialized at power-up.
5. Refer to Chip Enable Truth Table.

3198 tbl 16

Truth Table V —Address **BUSY** Arbitration⁽⁴⁾

Inputs			Outputs		Function
$\overline{CE}_L$	$\overline{CE}_R$	A _{0L} -A _{15L} A _{0R} -A _{15R}	$\overline{BUSY}_L^{(1)}$	$\overline{BUSY}_R^{(1)}$	
X	X	NO MATCH	H	H	Normal
H	X	MATCH	H	H	Normal
X	H	MATCH	H	H	Normal
L	L	MATCH	(2)	(2)	Write Inhibit ⁽³⁾

3198 tbl 17

NOTES:

1. Pins $\overline{BUSY}_L$ and $\overline{BUSY}_R$ are both outputs when the part is configured as a master. Both are inputs when configured as a slave. $\overline{BUSY}$ outputs on the IDT7008 are push-pull, not open drain outputs. On slaves the $\overline{BUSY}$ input internally inhibits writes.
2. "L" if the inputs to the opposite port were stable prior to the address and enable inputs of this port. "H" if the inputs to the opposite port became stable after the address and enable inputs of this port. If t_{APS} is not met, either $\overline{BUSY}_L$ or $\overline{BUSY}_R = \text{LOW}$ will result. $\overline{BUSY}_L$ and $\overline{BUSY}_R$ outputs can not be LOW simultaneously.
3. Writes to the left port are internally ignored when $\overline{BUSY}_L$ outputs are driving LOW regardless of actual logic level on the pin. Writes to the right port are internally ignored when $\overline{BUSY}_R$ outputs are driving LOW regardless of actual logic level on the pin.
4. Refer to Chip Enable Truth Table.

Truth Table VI — Example of Semaphore Procurement Sequence^(1,2,3)

Functions	D ₀ - D ₇ Left	D ₀ - D ₇ Right	Status
No Action	1	1	Semaphore free
Left Port Writes "0" to Semaphore	0	1	Left port has semaphore token
Right Port Writes "0" to Semaphore	0	1	No change. Right side has no write access to semaphore
Left Port Writes "1" to Semaphore	1	0	Right port obtains semaphore token
Left Port Writes "0" to Semaphore	1	0	No change. Left port has no write access to semaphore
Right Port Writes "1" to Semaphore	0	1	Left port obtains semaphore token
Left Port Writes "1" to Semaphore	1	1	Semaphore free
Right Port Writes "0" to Semaphore	1	0	Right port has semaphore token
Right Port Writes "1" to Semaphore	1	1	Semaphore free
Left Port Writes "0" to Semaphore	0	1	Left port has semaphore token
Left Port Writes "1" to Semaphore	1	1	Semaphore free

3198 tbl 18

NOTES:

1. This table denotes a sequence of events for only one of the eight semaphores on the IDT7008.
2. There are eight semaphore flags written to via I/O₀ and read from all I/O's (I/O₀-I/O₇). These eight semaphores are addressed by A₀-A₂.
3. $\overline{CE} = V_{IH}$, $\overline{SEM} = V_{IL}$ to access the semaphores. Refer to the Semaphore Read/Write Control Truth Table.

Functional Description

The IDT7008 provides two ports with separate control, address and I/O pins that permit independent access for reads or writes to any location in memory. The IDT7008 has an automatic power down feature controlled by $\overline{CE}$. The $\overline{CE}_0$ and $\overline{CE}_1$ control the on-chip power down circuitry that permits the respective port to go into a standby mode when not selected ($\overline{CE}$ HIGH). When a port is enabled, access to the entire memory array is permitted.

Interrupts

If the user chooses the interrupt function, a memory location (mail box or message center) is assigned to each port. The left port interrupt flag

(INT_L) is asserted when the right port writes to memory location FFFE (HEX), where a write is defined as $\overline{CE}_R = R/\overline{W} = V_{IL}$ per the Truth Table. The left port clears the interrupt through access of address location FFFE when $\overline{CE}_L = \overline{OE}_L = V_{IL}$, $R/\overline{W}$ is a "don't care". Likewise, the right port interrupt flag (INT_R) is asserted when the left port writes to memory location FFFF (HEX) and to clear the interrupt flag (INT_R), the right port must read the memory location FFFF. The message (8 bits) at FFFE or FFFF is user-defined since it is an addressable SRAM location. If the interrupt function is not used, address locations FFFE and FFFF are not used as mail boxes, but as part of the random access memory. Refer to Table IV for the interrupt operation.

Busy Logic

Busy Logic provides a hardware indication that both ports of the RAM have accessed the same location at the same time. It also allows one of the two accesses to proceed and signals the other side that the RAM is "busy". The $\overline{\text{BUSY}}$ pin can then be used to stall the access until the operation on the other side is completed. If a write operation has been attempted from the side that receives a $\overline{\text{BUSY}}$ indication, the write signal is gated internally to prevent the write from proceeding.

The use of $\overline{\text{BUSY}}$ logic is not required or desirable for all applications. In some cases it may be useful to logically OR the $\overline{\text{BUSY}}$ outputs together and use any $\overline{\text{BUSY}}$ indication as an interrupt source to flag the event of an illegal or illogical operation. If the write inhibit function of $\overline{\text{BUSY}}$ logic is not desirable, the $\overline{\text{BUSY}}$ logic can be disabled by placing the part in slave mode with the $\overline{\text{M/S}}$ pin. Once in slave mode the $\overline{\text{BUSY}}$ pin operates solely as a write inhibit input pin. Normal operation can be programmed by tying the $\overline{\text{BUSY}}$ pins HIGH. If desired, unintended write operations can be prevented to a port by tying the $\overline{\text{BUSY}}$ pin for that port LOW.

The $\overline{\text{BUSY}}$ outputs on the IDT7008 RAM in master mode, are push-pull type outputs and do not require pull up resistors to operate. If these RAMs are being expanded in depth, then the $\overline{\text{BUSY}}$ indication for the resulting array requires the use of an external AND gate.

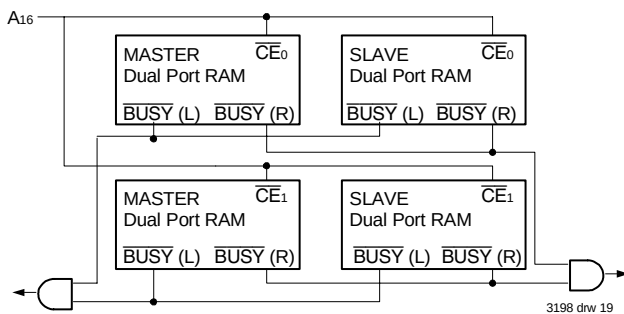


Figure 3. Busy and chip enable routing for both width and depth expansion with IDT7008 RAMs.

Width Expansion Busy Logic Master/Slave Arrays

When expanding an IDT7008 RAM array in width while using $\overline{\text{BUSY}}$ logic, one master part is used to decide which side of the RAMs array will receive a $\overline{\text{BUSY}}$ indication, and to output that indication. Any number of slaves to be addressed in the same address range as the master, use the $\overline{\text{BUSY}}$ signal as a write inhibit signal. Thus on the IDT7008 RAM the $\overline{\text{BUSY}}$ pin is an output if the part is used as a master ($\overline{\text{M/S}}$ pin = V_{IH}), and the $\overline{\text{BUSY}}$ pin is an input if the part is used as a slave ($\overline{\text{M/S}}$ pin = V_{IL}) as shown in Figure 3.

If two or more master parts were used when expanding in width, a split decision could result with one master indicating $\overline{\text{BUSY}}$ on one side of the array and another master indicating $\overline{\text{BUSY}}$ on one other side of the array. This would inhibit the write operations from one port for part of a word and inhibit the write operations from the other port for the other part of the word.

The $\overline{\text{BUSY}}$ arbitration, on a master, is based on the chip enable and address signals only. It ignores whether an access is a read or write. In a master/slave array, both address and chip enable must be valid long enough for a $\overline{\text{BUSY}}$ flag to be output from the master before the actual write pulse can be initiated with the R/W signal. Failure to observe this timing can

result in a glitched internal write inhibit signal and corrupted data in the slave.

Semaphores

The IDT7008 is an extremely fast Dual-Port 64K x 8 CMOS Static RAM with an additional 8 address locations dedicated to binary semaphore flags. These flags allow either processor on the left or right side of the Dual-Port RAM to claim a privilege over the other processor for functions defined by the system designer's software. As an example, the semaphore can be used by one processor to inhibit the other from accessing a portion of the Dual-Port RAM or any other shared resource.

The Dual-Port RAM features a fast access time, and both ports are completely independent of each other. This means that the activity on the left port in no way slows the access time of the right port. Both ports are identical in function to standard CMOS Static RAM and can be read from, or written to, at the same time with the only possible conflict arising from the simultaneous writing of, or a simultaneous READ/WRITE of, a non-semaphore location. Semaphores are protected against such ambiguous situations and may be used by the system program to avoid any conflicts in the non-semaphore portion of the Dual-Port RAM. These devices have an automatic power-down feature controlled by $\overline{\text{CE}}$, the Dual-Port RAM enable, and $\overline{\text{SEM}}$, the semaphore enable. The $\overline{\text{CE}}$ and $\overline{\text{SEM}}$ pins control on-chip power down circuitry that permits the respective port to go into standby mode when not selected. This is the condition which is shown in Truth Table II where $\overline{\text{CE}}$ and $\overline{\text{SEM}}$ are both HIGH.

Systems which can best use the IDT7008 contain multiple processors or controllers and are typically very high-speed systems which are software controlled or software intensive. These systems can benefit from a performance increase offered by the IDT7008s hardware semaphores, which provide a lockout mechanism without requiring complex programming.

Software handshaking between processors offers the maximum in system flexibility by permitting shared resources to be allocated in varying configurations. The IDT7008 does not use its semaphore flags to control any resources through hardware, thus allowing the system designer total flexibility in system architecture.

An advantage of using semaphores rather than the more common methods of hardware arbitration is that wait states are never incurred in either processor. This can prove to be a major advantage in very high-speed systems.

How the Semaphore Flags Work

The semaphore logic is a set of eight latches which are independent of the Dual-Port RAM. These latches can be used to pass a flag, or token, from one port to the other to indicate that a shared resource is in use. The semaphores provide a hardware assist for a use assignment method called "Token Passing Allocation." In this method, the state of a semaphore latch is used as a token indicating that shared resource is in use. If the left processor wants to use this resource, it requests the token by setting the latch. This processor then verifies its success in setting the latch by reading it. If it was successful, it proceeds to assume control over the shared resource. If it was not successful in setting the latch, it determines that the right side processor has set the latch first, has the token and is using the shared resource. The left processor can then either repeatedly request that semaphore's status or remove its request for that semaphore to perform another task and occasionally attempt again to gain control of the token via

the set and test sequence. Once the right side has relinquished the token, the left side should succeed in gaining control.

The semaphore flags are active LOW. A token is requested by writing a zero into a semaphore latch and is released when the same side writes a one to that latch.

The eight semaphore flags reside within the IDT7008 in a separate memory space from the Dual-Port RAM. This address space is accessed by placing a LOW input on the $\overline{SEM}$ pin (which acts as a chip select for the semaphore flags) and using the other control pins (Address, $\overline{CE}$, and R/W) as they would be used in accessing a standard Static RAM. Each of the flags has a unique address which can be accessed by either side through address pins A0–A2. When accessing the semaphores, none of the other address pins has any effect.

When writing to a semaphore, only data pin D0 is used. If a LOW level is written into an unused semaphore location, that flag will be set to a zero on that side and a one on the other side (see Table VI). That semaphore can now only be modified by the side showing the zero. When a one is written into the same location from the same side, the flag will be set to a one for both sides (unless a semaphore request from the other side is pending) and then can be written to by both sides. The fact that the side which is able to write a zero into a semaphore subsequently locks out writes from the other side is what makes semaphore flags useful in interprocessor communications. (A thorough discussion on the use of this feature follows shortly.) A zero written into the same location from the other side will be stored in the semaphore request latch for that side until the semaphore is freed by the first side.

When a semaphore flag is read, its value is spread into all data bits so that a flag that is a one reads as a one in all data bits and a flag containing a zero reads as all zeros. The read value is latched into one side's output register when that side's semaphore select ($\overline{SEM}$) and output enable ($\overline{OE}$) signals go active. This serves to disallow the semaphore from changing state in the middle of a read cycle due to a write cycle from the other side. Because of this latch, a repeated read of a semaphore in a test loop must cause either signal ($\overline{SEM}$ or $\overline{OE}$) to go inactive or the output will never change.

A sequence WRITE/READ must be used by the semaphore in order to guarantee that no system level contention will occur. A processor requests access to shared resources by attempting to write a zero into a semaphore location. If the semaphore is already in use, the semaphore request latch will contain a zero, yet the semaphore flag will appear as one, a fact which the processor will verify by the subsequent read (see Table VI). As an example, assume a processor writes a zero to the left port at a free semaphore location. On a subsequent read, the processor will verify that it has written successfully to that location and will assume control over the resource in question. Meanwhile, if a processor on the right side attempts to write a zero to the same semaphore flag it will fail, as will be verified by the fact that a one will be read from that semaphore on the right

side during subsequent read. Had a sequence of READ/WRITE been used instead, system contention problems could have occurred during the gap between the read and write cycles.

It is important to note that a failed semaphore request must be followed by either repeated reads or by writing a one into the same location. The reason for this is easily understood by looking at the simple logic diagram of the semaphore flag in Figure 4. Two semaphore request latches feed into a semaphore flag. Whichever latch is first to present a zero to the semaphore flag will force its side of the semaphore flag LOW and the other side HIGH. This condition will continue until a one is written to the same semaphore request latch. Should the other side's semaphore request latch have been written to a zero in the meantime, the semaphore flag will flip

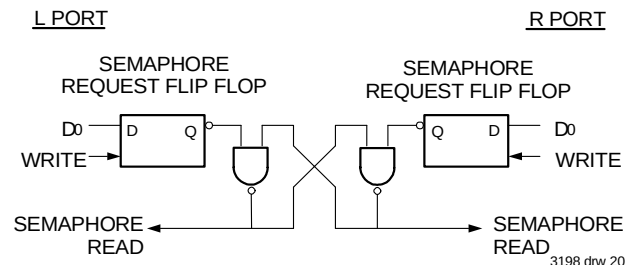


Figure 4. IDT7008 Semaphore Logic

over to the other side as soon as a one is written into the first side's request latch. The second side's flag will now stay LOW until its semaphore request latch is written to a one. From this it is easy to understand that, if a semaphore is requested and the processor which requested it no longer needs the resource, the entire system can hang up until a one is written into that semaphore request latch.

The critical case of semaphore timing is when both sides request a single token by attempting to write a zero into it at the same time. The semaphore logic is specially designed to resolve this problem. If simultaneous requests are made, the logic guarantees that only one side receives the token. If one side is earlier than the other in making the request, the first side to make the request will receive the token. If both requests arrive at the same time, the assignment will be arbitrarily made to one port or the other.

One caution that should be noted when using semaphores is that semaphores alone do not guarantee that access to a resource is secure. As with any powerful programming technique, if semaphores are misused or misinterpreted, a software error can easily happen.

Initialization of the semaphores is not automatic and must be handled via the initialization program at power-up. Since any semaphore request flag which contains a zero must be reset to a one, all semaphores on both sides should have a one written into them at initialization from both sides to assure that they will be free when needed.

Ordering Information

XXXXX	A	999	A	A	A	A		
Device Type	Power	Speed	Package		Process/ Temperature Range			
							Blank 8	Tube or Tray Tape and Reel
							Blank I ⁽¹⁾	Commercial (0°C to +70°C) Industrial (-40°C to +85°C)
							G ⁽²⁾	Green
							PF	100-pin TQFP (PN100)
							G	84-pin PGA (G84)
							J	84-pin PLCC (J84)
							15	Commercial Only
							20	Commercial & Industrial
							25	Commercial Only
							35	Commercial Only
							55	Commercial & Industrial
							} Speed in nanoseconds	
							S	Standard Power
							L	Low Power
							7008	512K (64K x 8) Dual-Port RAM

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NOTES:

- Industrial temperature range is available on selected TQFP packages in standard power. For other speeds, packages and powers contact your sales office.
- Green parts available. For specific speeds, packages and powers contact your local sales office.

LEAD FINISH (SnPb) parts are in EOL process. Product Discontinuation Notice - PDN# SP-17-02

Datasheet Document History

01/06/99:		Initiated datasheet document history
		Converted to new format
		Cosmetic and typographical corrections
06/03/99:	Pages 2 and 3	Added additional notes to pin configurations
11/10/99:		Changed drawing format
05/08/99:	Page 6	Replaced IDT logo
		Increased storage temperature parameter
		Clarified T _A parameter
	Page 7	DC Electrical parameters—changed wording from "open" to "disabled"
		Changed ±200mV to 0mV in notes
07/26/04:	Page 2 - 4	Added date revision for pin configurations
	Page 6	Updated Capacitance table
	Page 7	Added 15ns commercial speed grade to the DC Electrical Characteristics
		Added 20ns Industrial temp for low power to DC Electrical Characteristics
	Page 9, 12 & 14	Added 15ns commercial speed grade to AC Electrical Characteristics
		Added 20ns Industrial temp for low power to AC Electrical Characteristics for Read, Write, Busy and Interrupt
	Page 19	Added Commercial for 15ns and Industrial temp to 20ns in ordering information
	Page 1 & 19	Replaced old τ_{M} logo with new τ_{M} logo

Datasheet Document History (con't)

04/03/06:	Page 1	Added green availability to features
	Page 19	Added green indicator to ordering information
10/21/08:	Page 19	Removed "IDT" from orderable part number
10/02/14:	Page 19	Added Tape & Reel to Ordering Information
	Page 2, 3, 4 & 19	The package codes for PN100-1, G108-1 & J84-1 changed to PN100, G108 & J84 respectively to match standard package codes
04/06/16:	Page 2	Changed diagram for the J84 pin configuration by rotating package pin labels and pin numbers 90 degrees clockwise to reflect pin1 orientation and added pin 1 dot at pin 1
		Removed J84 chamfer and aligned the top and bottom pin labels in the standard direction
	Page 3	Changed diagram for the PN100 pin configuration by rotating package pin labels and pin numbers 90 degrees counter clockwise to reflect pin 1 orientation and added pin 1 dot at pin 1
		Added the IDT logo, changed the text to be in alignment with new diagram marking specs, removed date from all pin configurations and updated footnote references for the J84 & the PN100 pin configurations
	Page 6	Military grade removed from Absolute Max and Max Operating tables
03/06/18:	Page 7, 9, 12 & 14	Military grade removed from all DC Elec & all AC Elec tables for all speeds
	Page 19	Military grade removed from Ordering Information
		Product Discontinuation Notice - PDN# SP-17-02 Last time buy expires June 15, 2018



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[7008S55PFI](#) [7008S15J8](#) [7008L35J](#) [7008L35G](#) [7008S55PF](#) [7008L15J](#) [7008L15PFG](#) [7008L55G](#) [7008L55J](#)
[7008L20PFGI](#) [7008L20J](#) [7008L25G](#) [7008L25J](#) [7008L25PF8](#) [7008L15PFG8](#) [7008L35J8](#) [7008S25J8](#) [7008S25PF8](#)
[7008S20J8](#) [7008S15PF](#) [7008S55J8](#) [7008L55PF8](#) [7008L20PF](#) [7008L20JI](#) [7008L20PFI8](#) [7008L15J8](#) [7008L25PF](#)
[7008S35PF](#) [7008S35J8](#) [7008L35PF8](#) [7008L35PF](#) [7008L55PF](#) [7008S20PF](#) [7008S25PF](#) [7008S55PF8](#) [7008L20PFI](#)
[7008L15PF](#) [7008L15JG](#) [7008S55G](#) [7008S55J](#) [7008S25J](#) [7008S20J](#) [7008S25G](#) [7008S15J](#) [7008S35J](#) [7008S35G](#)
[7008S15PF8](#) [7008S35PF8](#) [7008L20PFGI8](#) [7008L55J8](#) [7008L15PF8](#) [7008L15JG8](#) [7008S20PF8](#) [7008L20PF8](#)
[7008L20JI8](#) [7008L20J8](#) [7008L25J8](#) [7008S55PFI8](#) [7008L20JGI](#) [7008L20JGI8](#)

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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